



AP7350

150mA ULTRA-LOW QUIESCENT CURRENT LDO with ENABLE

Description

The AP7350 is a low dropout regulator with high output voltage accuracy. The AP7350 includes a voltage reference, error amplifier, current limit circuit and an enable input to turn it on/off. With the integrated resistor network, fixed output voltage versions can be delivered.

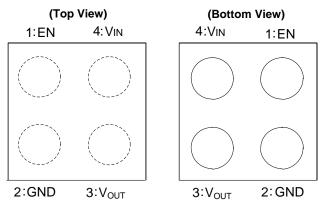
With its ultra-low quiescent current and miniature package dimensions, the AP7350 is well suited for low-power handheld, wearable devices, and other battery-operated devices requiring an extended time period until new battery replacement.

The AP7350 is available in the wafer level chip scale X2-WLB0606-4 package. This part is one of the smallest LDO footprints in the industry allowing for the use of a bare minimum of board space within the application.

Features

- Low V_{IN} and Wide V_{IN} Range: 2.0V to 5.25V
- Guarantee Output Current, 150mA
- Output Voltage Range: 1.2V to 4.5V
- Vout Accuracy: ±1%
- Quiescent Current as Low as 0.25µA
- Typical Standby Current 0.02µA
- ESD Protection Exceeds JESD 22
 - Exceeds 4000V Human Body Model (A114)
 - Exceeds 400V Machine Model (A115)
- Latch-Up Exceeds 400mA per JESD 78, Class I
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish SnAgCu Balls, Solderable per MIL-STD-202, Method 208 (1)
- Weight: 0.01 grams (Approximate)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Pin Assignments



X2-WLB0606-4

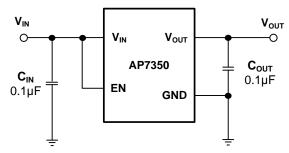
Applications

- Wearable Electronics
- Sensor Module for Internet-of-Things (IoT)
- Wireless Communication Module
- Battery-Operated Device
- Camera
- Image Sensor

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit (Notes 4 & 5)



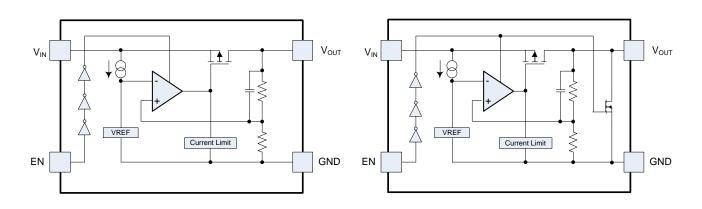
Notes: 4. X5R- and X7R-type capacitors are suggested due to their minimal variation in value and ESR over temperature.



Pin Descriptions

Pin Number	Pin Name	Function		
1	EN	Channel enable pin. This pin should be driven either high or low and must not be floating. Driving this pin high enables regulator output, while pulling it low enable regulator into shutdown mode.		
2	GND	Ground		
3	Vouт	Output voltage pin		
4	Vin	Power input pin		

Functional Block Diagram



AP7350 (Without Discharge)

AP7350D (With Discharge)

Absolute Maximum Ratings (Note 6)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
Vin	Input Voltage	6.0	V
VEN	Input Voltage at EN pin	6.0	V
Vout	Output Voltage to GND	-0.3 to V _{IN} +0.3	V
TA	Operating Ambient Temperature	-40 to +85	°C
TJ	Maximum Junction Temperature	+125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
PD	Power Dissipation (Note 7)	315	mW

Notes:

^{6.} Stresses beyond those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.

^{7.} This is based on an application temperature of +40°C. Derate 3.75mW per °C for each degree above +40°C.



Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
Vin	Input Voltage	2.0	5.25	V
Іоит	Output Current	0	150	mA
T _A Operating Ambient Temperature		-40	+85	°C

Electrical Characteristics (@TA = +25°C, VEN = VIN = 5.0V (VOUT > 4.0V), VEN = VIN = VOUT+1V (1.5V < VOUT \leq 4.0V), VEN = VIN = 2.5V (VOUT \leq 1.5V), IOUT = 1mA, CIN = COUT = 0.1µF, unless otherwise specified.)

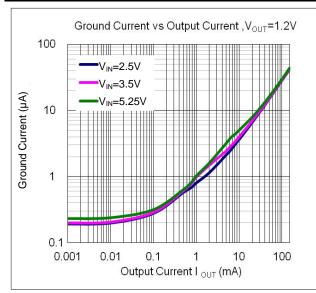
Parameter	Conditions		Min	Тур	Max	Unit
Input Voltage	T _A = -40°C to +85°C		2.0	_	5.25	V
	Vout > 2.0V lout = 1mA	T _A = +25°C	-1	_	+1	%
Outrot Wallana Assuran		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	-2	_	+2	
Output Voltage Accuracy	Vout ≤ 2.0V	T _A = +25°C	-40	1	40	mV
	I _{OUT} = 1mA	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	-80	ı	80	
Line Regulation (ΔVουτ/ΔVιΝ/Vουτ)	MAX (Vout + 1.0V, 2	$2.5V) \le V_{IN} \le 5.0V$	_	0.02	0.1	%/V
Load Decidation (AV)	$1 \text{mA} \le I_{\text{OUT}} \le 150 \text{mA}$	A (all versions except 4.5V)	-25	1	25	mV
Load Regulation (∆V _{ОUТ})	$1mA \le I_{OUT} \le 150mA$	A (applicable to 4.5V version)	-45		45	mV
Short Circuit Current Limit (Note 8)	V _{OUT} = 0V		_	60	_	mA
Octobrond Octobrond (Nieto O)) Om A	T _A = +25°C	_	0.25	0.4	μΑ
Quiescent Current (Note 9)	I _{OUT} = 0mA	$T_A = -40$ °C to $+85$ °C	_	_	0.7	μΑ
Standby Current (ISTANDBY)	Set EN low, No load		_	0.02	0.2	μA
Output Current	Vin ≥ Vout + Vdropout		150	_	_	mA
		Vout = 1.2V	_	0.60	0.90	
		Vout = 1.5V	_	0.43	0.75	V
	I _{OUT} = 150mA	Vout = 1.8V	_	0.33	0.60	
		V _{OUT} = 1.85V	_	0.32	0.58	
		$V_{OUT} = 2.3V$	_	0.25	0.51	
Dropout Voltage (Note 10)		V _{OUT} = 2.5V	_	0.22	0.48	
		Vout = 2.7V	_	0.21	0.44	
		Vout = 2.8V	_	0.19	0.40	
		Vout = 3.0V	_	0.18	0.35	
		Vout = 3.3V	_	0.16	0.35	
		$V_{OUT} = 4.5V$	_	0.14	0.35	
Thermal Resistance Junction-to-Ambient (θ_{JA}) (Note 11)	Package: X2-WLB0606-4		_	267	_	°C/W
EN Input Low Voltage	_		_	_	0.4	V
EN Input High Voltage	_		1.0	_	5.25	V
Active Output Discharge Resistance (Note 12)	V _{IN} = 4.0V, V _{EN} = 0V		_	35	_	Ω

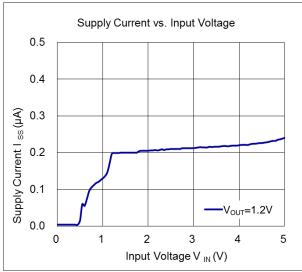
Notes:

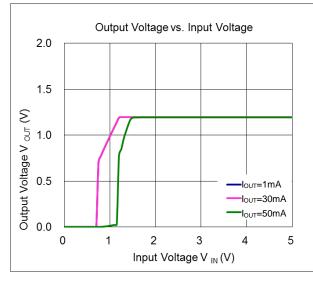
- 8. Short circuit current is measured with $V_{\mbox{\scriptsize OUT}}$ pulled to GND.
- 9. Quiescent current defined here is the difference in current between the input and the output.
- 10. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
- 11. Test condition: X2-WLB0606-4 is mounted on PCB (compliant with JEDEC standard).
- 12. AP7350 is available with 2 options: built-in discharge (AP7350D) and non-discharge (AP7350).

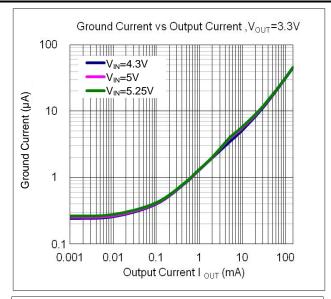


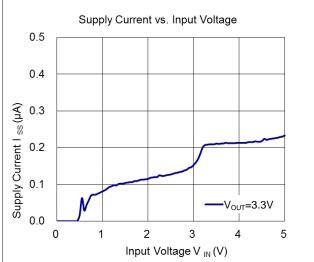
Performance Characteristics

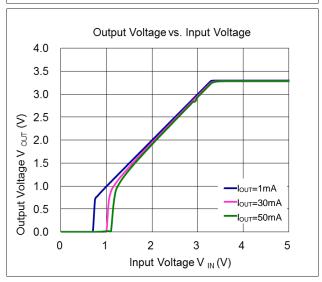




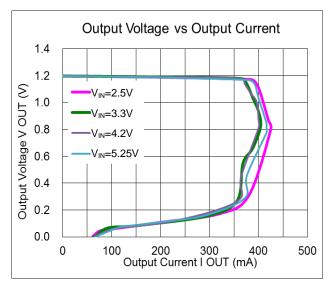


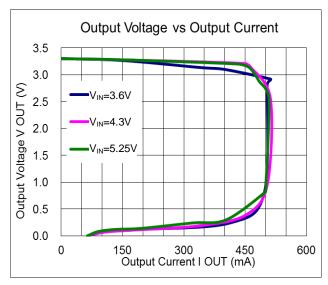


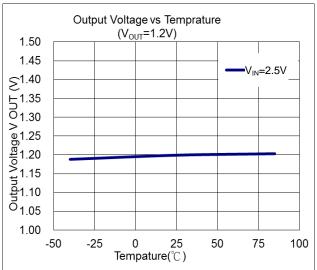


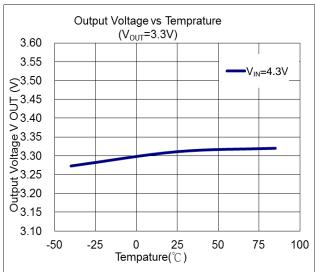


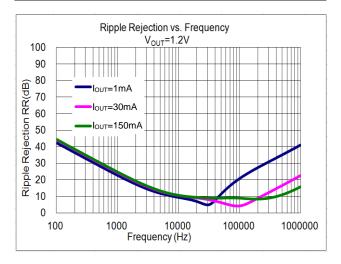


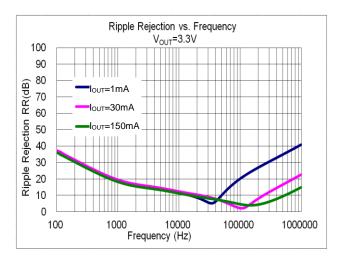




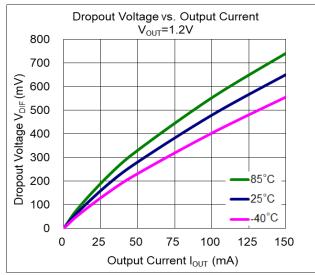


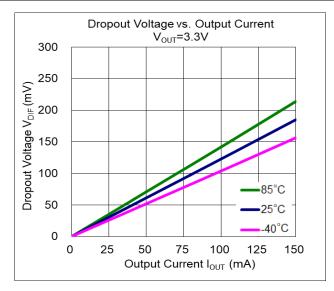


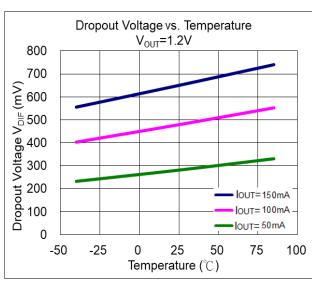


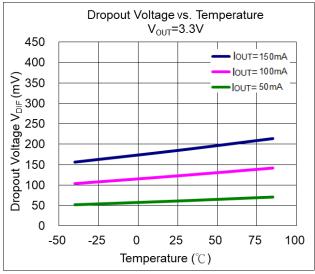




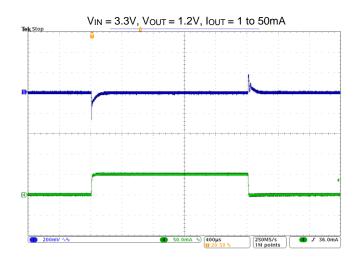


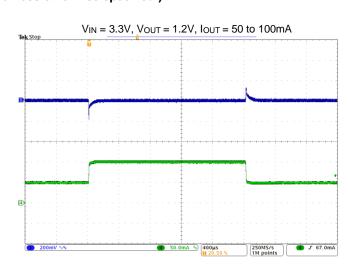






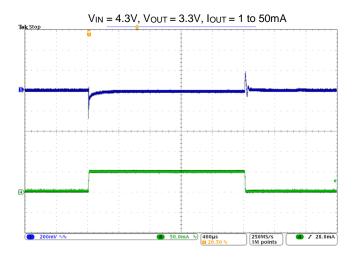
Load Transient Response ($C_{IN} = C_{OUT} = 0.1 \mu F$, $t_R = t_F = 5.0 \mu s$, unless otherwise specified.)

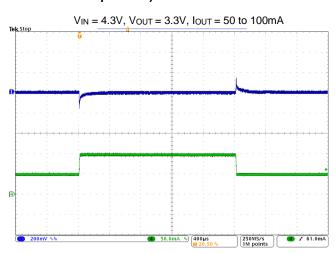




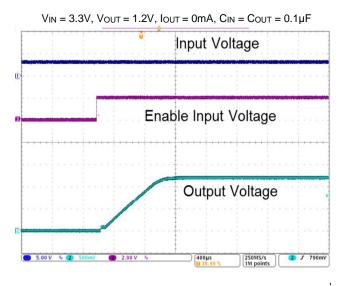


Load Transient Response ($C_{IN} = C_{OUT} = 0.1 \mu F$, $t_R = t_F = 5.0 \mu s$, unless otherwise specified.)

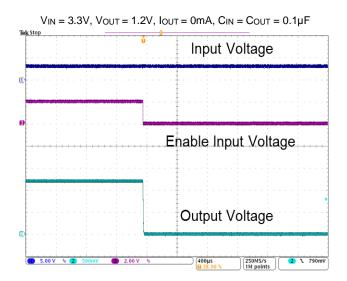


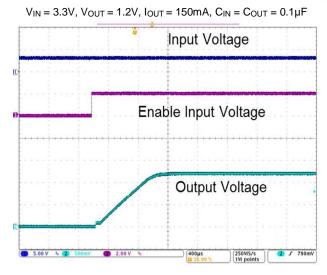


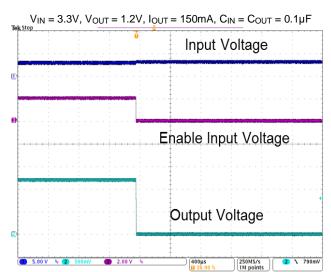
Turn On





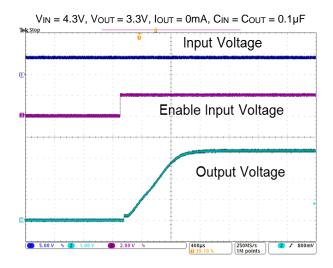




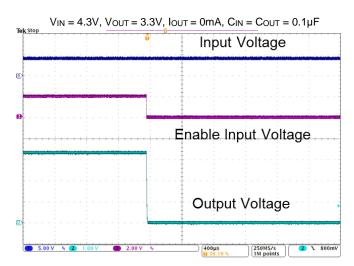


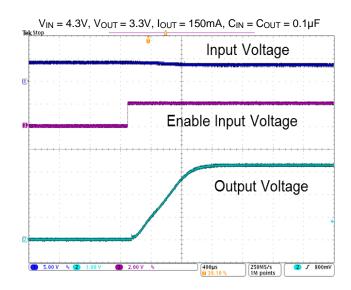


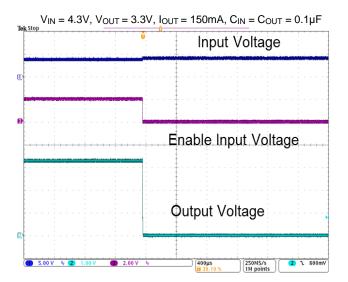
Turn On



Turn Off









Application Information

Output Capacitor

An output capacitor (Cout) is needed to improve transient response and maintain stability. The AP7350 is stable with very small ceramic output capacitors. The ESR (Equivalent Series Resistance) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin and care should be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum 0.1μ F ceramic capacitor is recommended between V_{IN} and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pin.

Enable Control

The AP7350 is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to V_{IN} pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section.

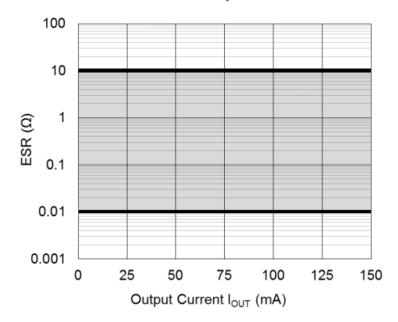
Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and GND pin of the device. The regulator GND pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from V_{IN} to V_{OUT}, and load circuit.

ESR vs. Output Current

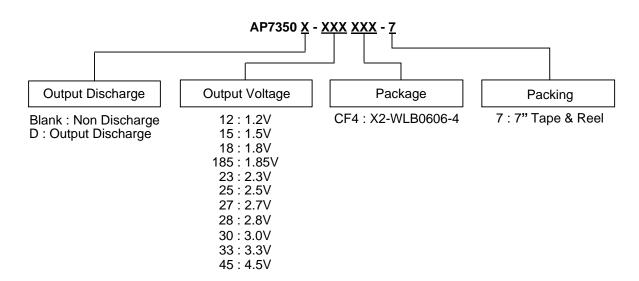
A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between IouT (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph. Measurement conditions: Frequency Band: 10Hz to 2MHz, Temperature: -40°C to +85°C.

ESR vs. Output Current





Ordering Information (Note 13)



Device	Device	Output	Package		7" Tape and Reel	
Without Discharge	With Discharge	Voltage	Code	Package	Quantity	Part Number Suffix
AP7350-12CF4-7	AP7350D-12CF4-7	1.2	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-15CF4-7	AP7350D-15CF4-7	1.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-18CF4-7	AP7350D-18CF4-7	1.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-185CF4-7	AP7350D-185CF4-7	1.85	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-23CF4-7	AP7350D-23CF4-7	2.3	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-25CF4-7	AP7350D-25CF4-7	2.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-27CF4-7	AP7350D-27CF4-7	2.7	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-28CF4-7	AP7350D-28CF4-7	2.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-30CF4-7	AP7350D-30CF4-7	3.0	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-33CF4-7	AP7350D-33CF4-7	3.3	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-45CF4-7	AP7350D-45CF4-7	4.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7

Note: 13. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

(1) X2-WLB0606-4

(Top View)

X or \overline{X} : Identification Code

Y: Year: 0~9

W : Week : A~Z : 1~26 week; a~z : 27~52 week; z represents

52 and 53 week

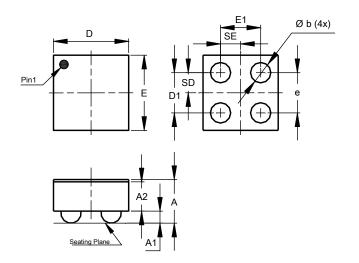
Part Number	Vоит	Package	Identification Code
AP7350-12CF4-7	1.2V	X2-WLB0606-4	A
AP7350-15CF4-7	1.5V	X2-WLB0606-4	В
AP7350-18CF4-7	1.8V	X2-WLB0606-4	С
AP7350-185CF4-7	1.85V	X2-WLB0606-4	R
AP7350-23CF4-7	2.3V	X2-WLB0606-4	9
AP7350-25CF4-7	2.5V	X2-WLB0606-4	D
AP7350-27CF4-7	2.7V	X2-WLB0606-4	\overline{A}
AP7350-28CF4-7	2.8V	X2-WLB0606-4	E
AP7350-30CF4-7	3.0V	X2-WLB0606-4	F
AP7350-33CF4-7	3.3V	X2-WLB0606-4	G
AP7350-45CF4-7	4.5V	X2-WLB0606-4	7
AP7350D-12CF4-7	1.2V	X2-WLB0606-4	Н
AP7350D-15CF4-7	1.5V	X2-WLB0606-4	J
AP7350D-18CF4-7	1.8V	X2-WLB0606-4	K
AP7350D-185CF4-7	1.85V	X2-WLB0606-4	S
AP7350D-23CF4-7	2.3V	X2-WLB0606-4	9
AP7350D-25CF4-7	2.5V	X2-WLB0606-4	L
AP7350D-27CF4-7	2.7V	X2-WLB0606-4	B
AP7350D-28CF4-7	2.8V	X2-WLB0606-4	M
AP7350D-30CF4-7	3.0V	X2-WLB0606-4	N
AP7350D-33CF4-7	3.3V	X2-WLB0606-4	Р
AP7350D-45CF4-7	4.5V	X2-WLB0606-4	8



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-WLB0606-4

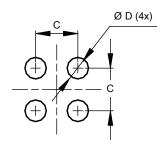


X2-WLB0606-4				
Dim	Min	Max	Тур	
Α	0.300	0.380	0.340	
A1	0.075	0.105	0.090	
A2	0.205	0.255	0.230	
b	0.110	0.190	0.150	
D	0.625	0.655	0.640	
D1	0.300	0.400	0.350	
Е	0.625	0.655	0.640	
E1	0.300	0.400	0.350	
е	0.350 BSC			
SD	0.175 BSC			
SE	0.175 BSC			
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

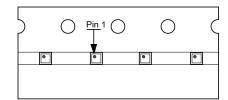
X2-WLB0606-4



Dimensions	Value (in mm)		
С	0.350		
D	0.150		

Tape Orientation

The taping orientation of the other package type can be found on our website at https://www.diodes.com/assets/Packaging-Support-Docs/Ap02007.pdf.





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